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**Hairapetian**

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(54) **CURRENT-CONTROLLED CMOS LOGIC FAMILY**

(75) Inventor: **Armond Hairapetian**, Newport Coast, CA (US)

(73) Assignee: **Broadcom Corporation**, Irvine, CA (US)

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This patent is subject to a terminal disclaimer.

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**Related U.S. Application Data**

(63) Continuation of application No. 11/114,969, filed on Apr. 26, 2005, now Pat. No. 7,038,516, which is a continuation of application No. 10/143,087, filed on May 9, 2002, now Pat. No. 6,900,670, which is a continuation of application No. 09/484,856, filed on Jan. 18, 2000, now Pat. No. 6,424,194.

(60) Provisional application No. 60/141,355, filed on Jun. 28, 1999.

(51) **Int. Cl.**  
**H03K 3/356** (2006.01)

(52) **U.S. Cl.** ..... 327/210; 327/219; 327/117; 327/119

(58) **Field of Classification Search** ..... 327/100, 327/210, 407, 415, 437; 326/62, 81

See application file for complete search history.

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*Primary Examiner*—Timothy P. Callahan

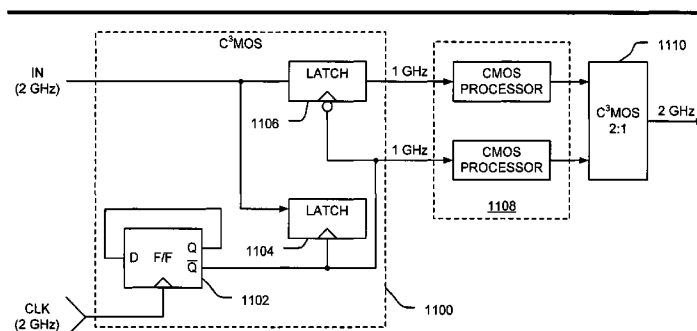
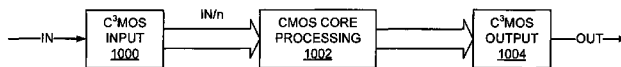
*Assistant Examiner*—Hai L. Nguyen

(74) *Attorney, Agent, or Firm*—Garlick Harrison & Markison; Shayne X. Short

(57) **ABSTRACT**

Various circuit techniques for implementing ultra high speed circuits use current-controlled CMOS (C<sup>3</sup>MOS) logic fabricated in conventional CMOS process technology. An entire family of logic elements including inverter/buffers, level shifters, NAND, NOR, XOR gates, latches, flip-flops and the like are implemented using C<sup>3</sup>MOS techniques. Optimum balance between power consumption and speed for each circuit application is achieved by combining high speed C<sup>3</sup>MOS logic with low power conventional CMOS logic. The combined C<sup>3</sup>MOS/CMOS logic allows greater integration of circuits such as high speed transceivers used in fiber optic communication systems.

**20 Claims, 9 Drawing Sheets**



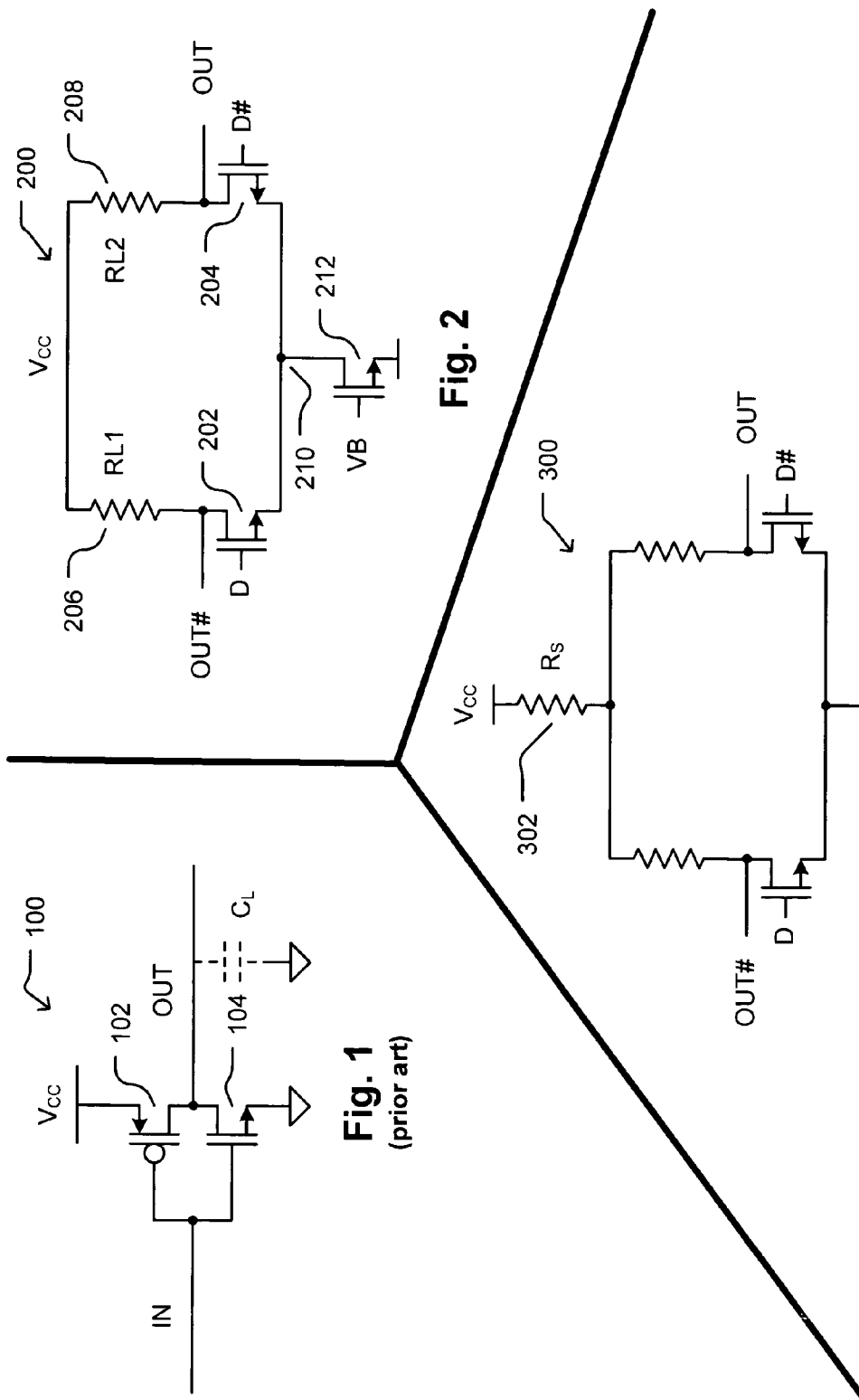


Fig. 1 (prior art)

Fig. 2

Fig. 3





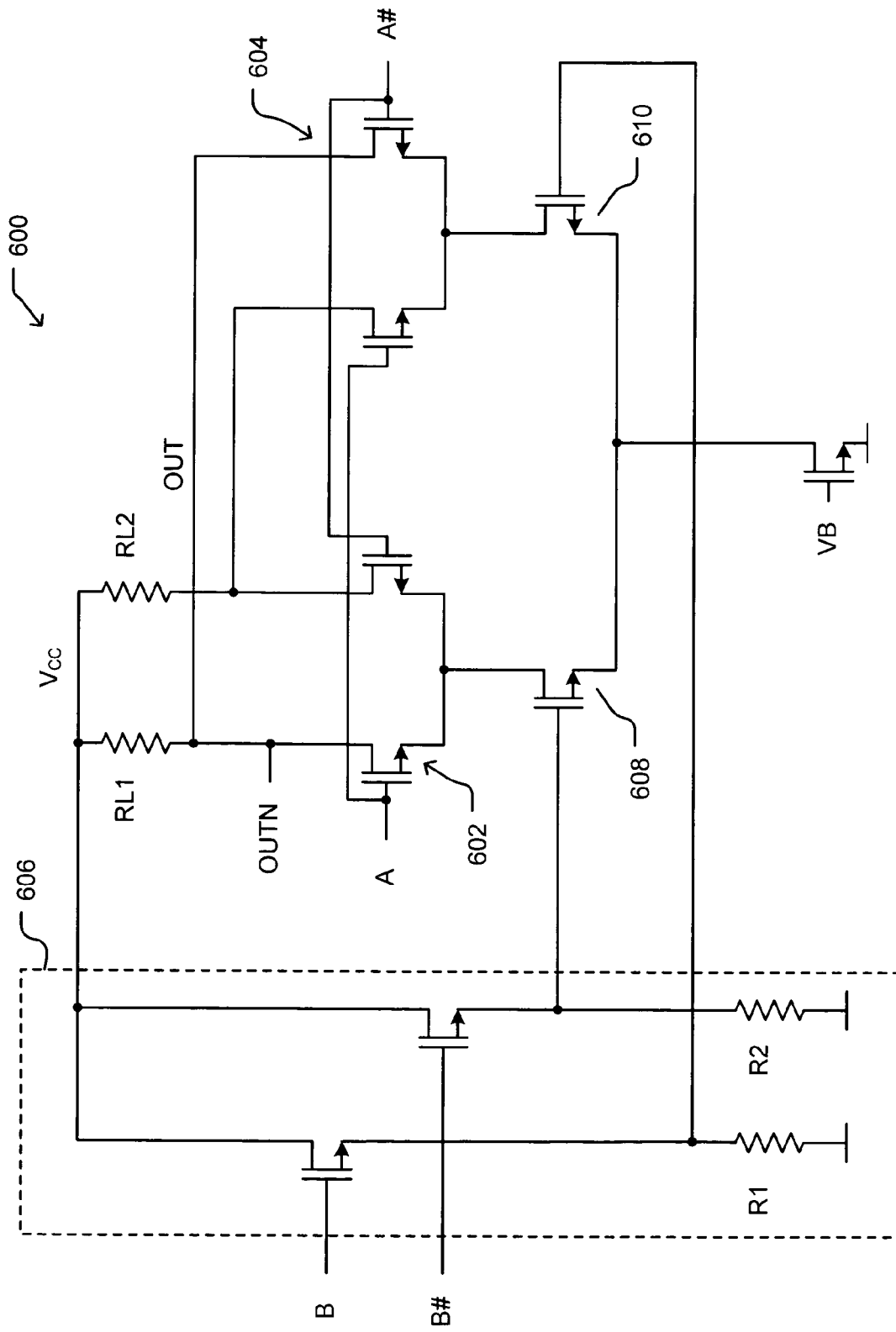


Fig. 6

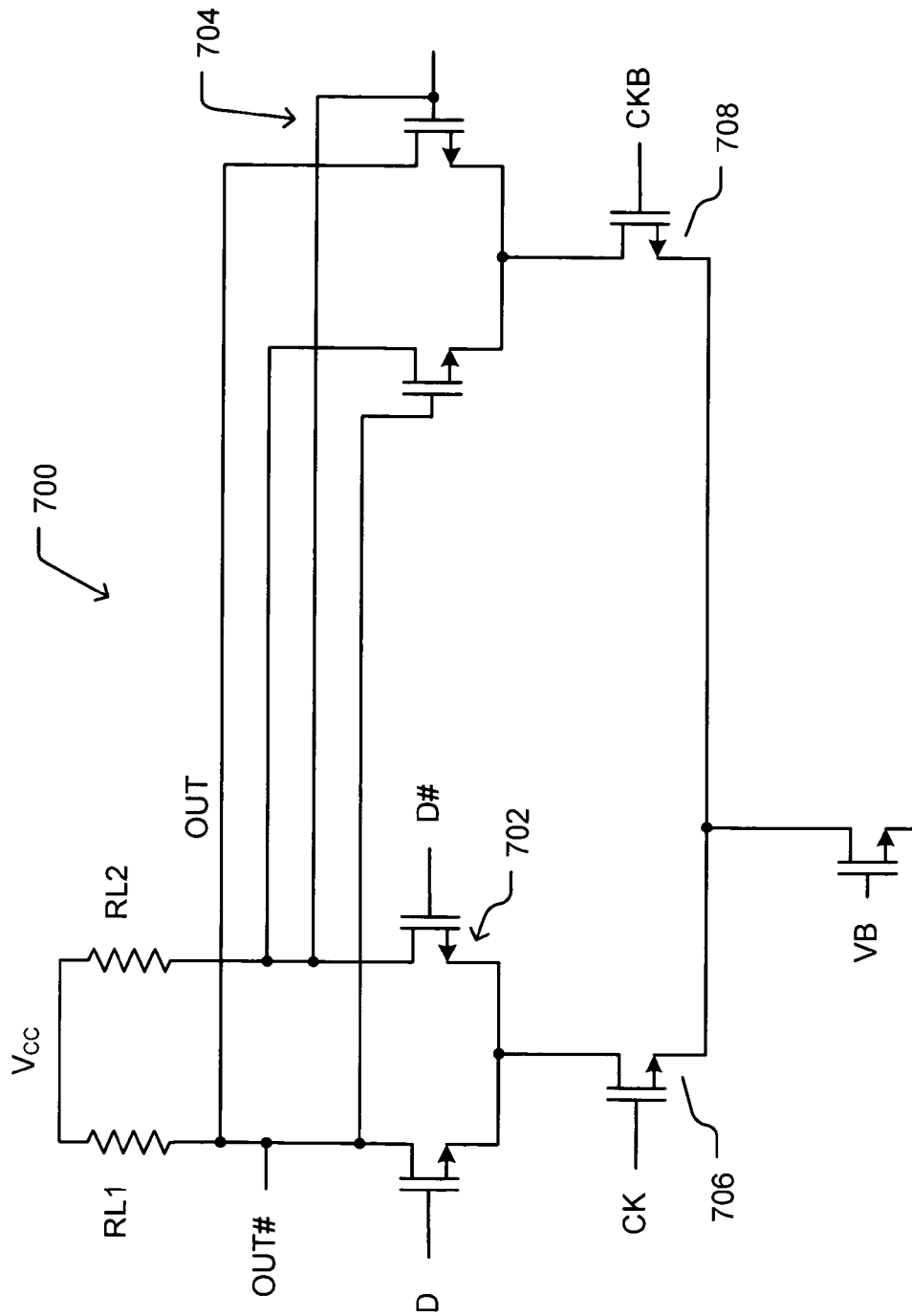


Fig. 7

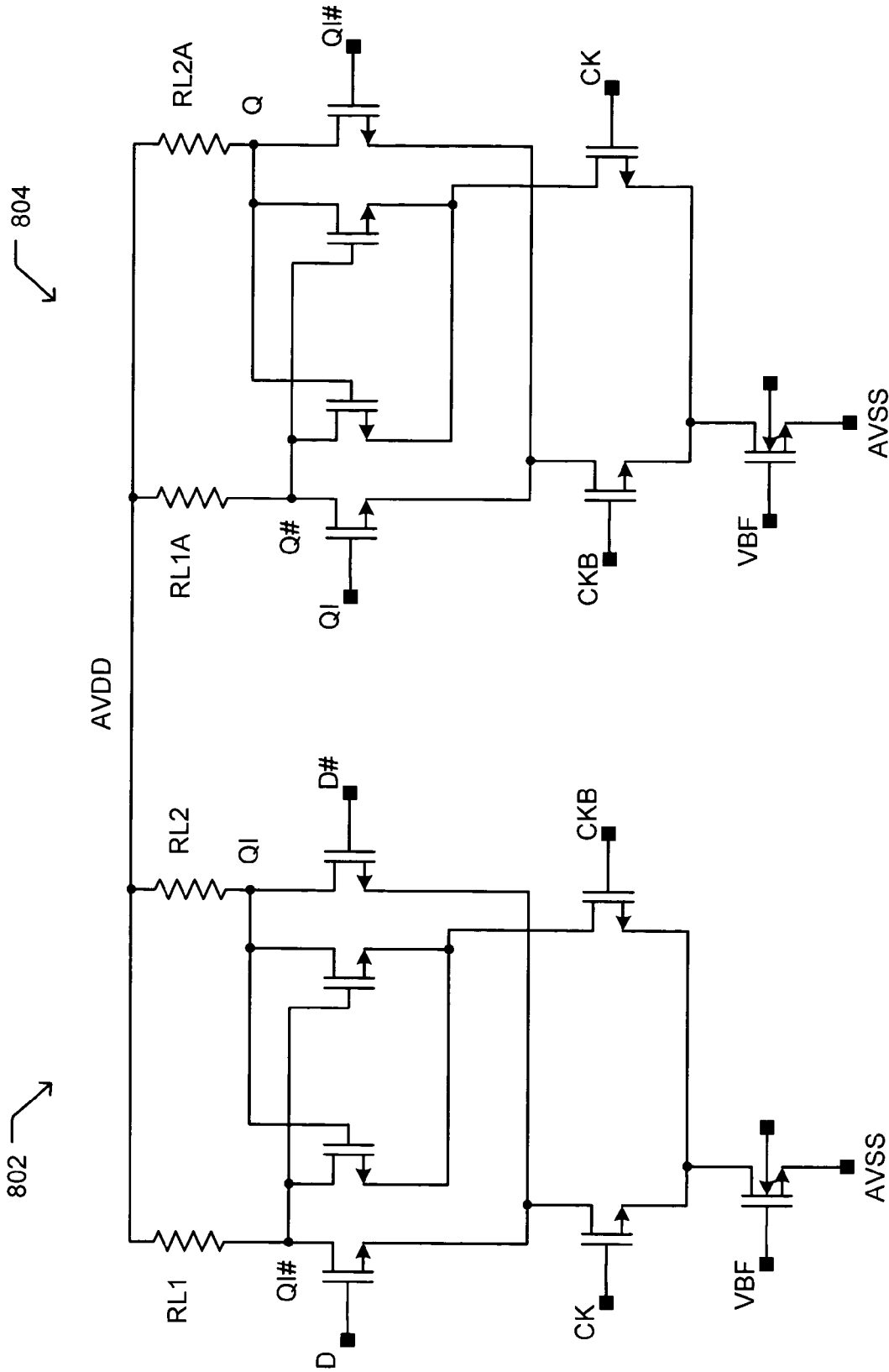


Fig. 8

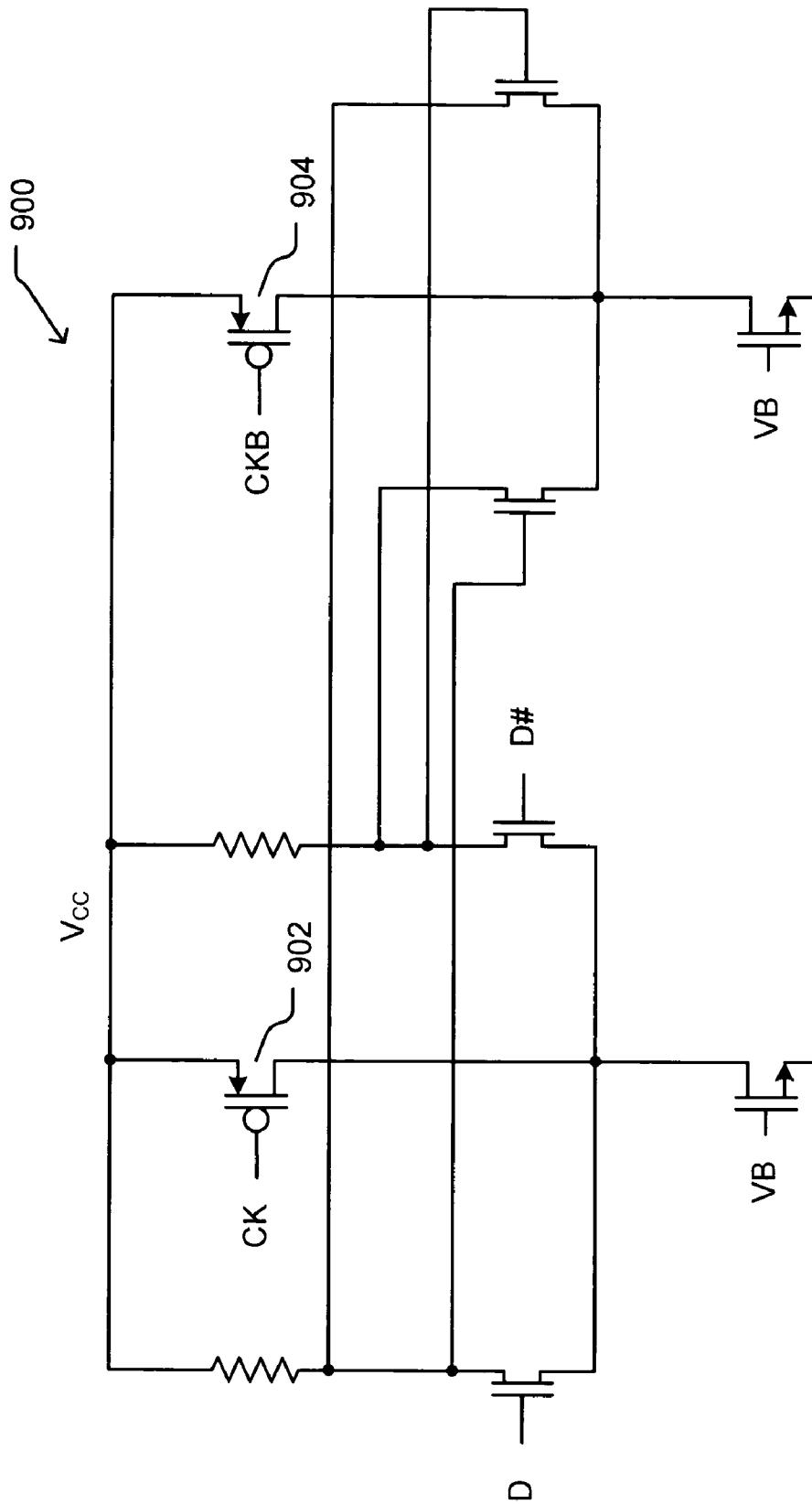


Fig. 9





Fig. 10

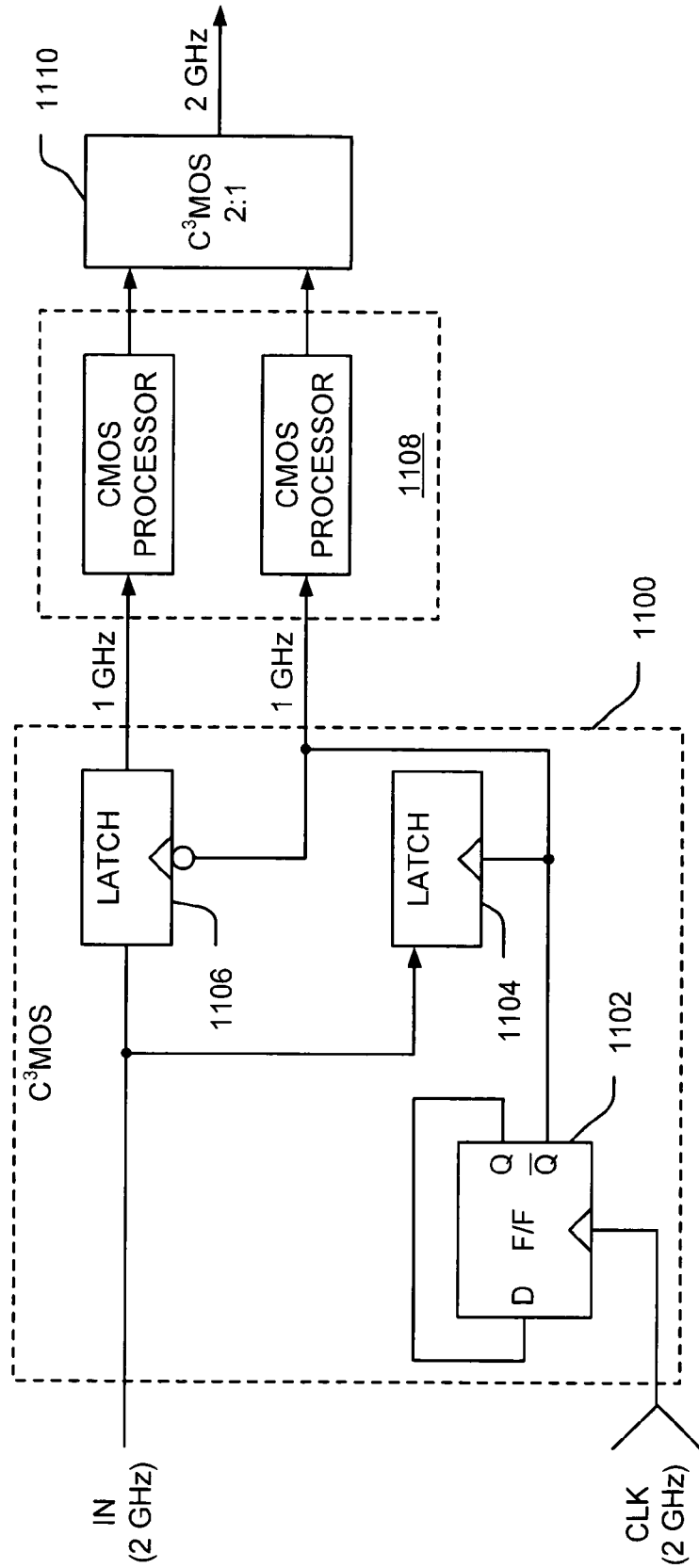


Fig. 11

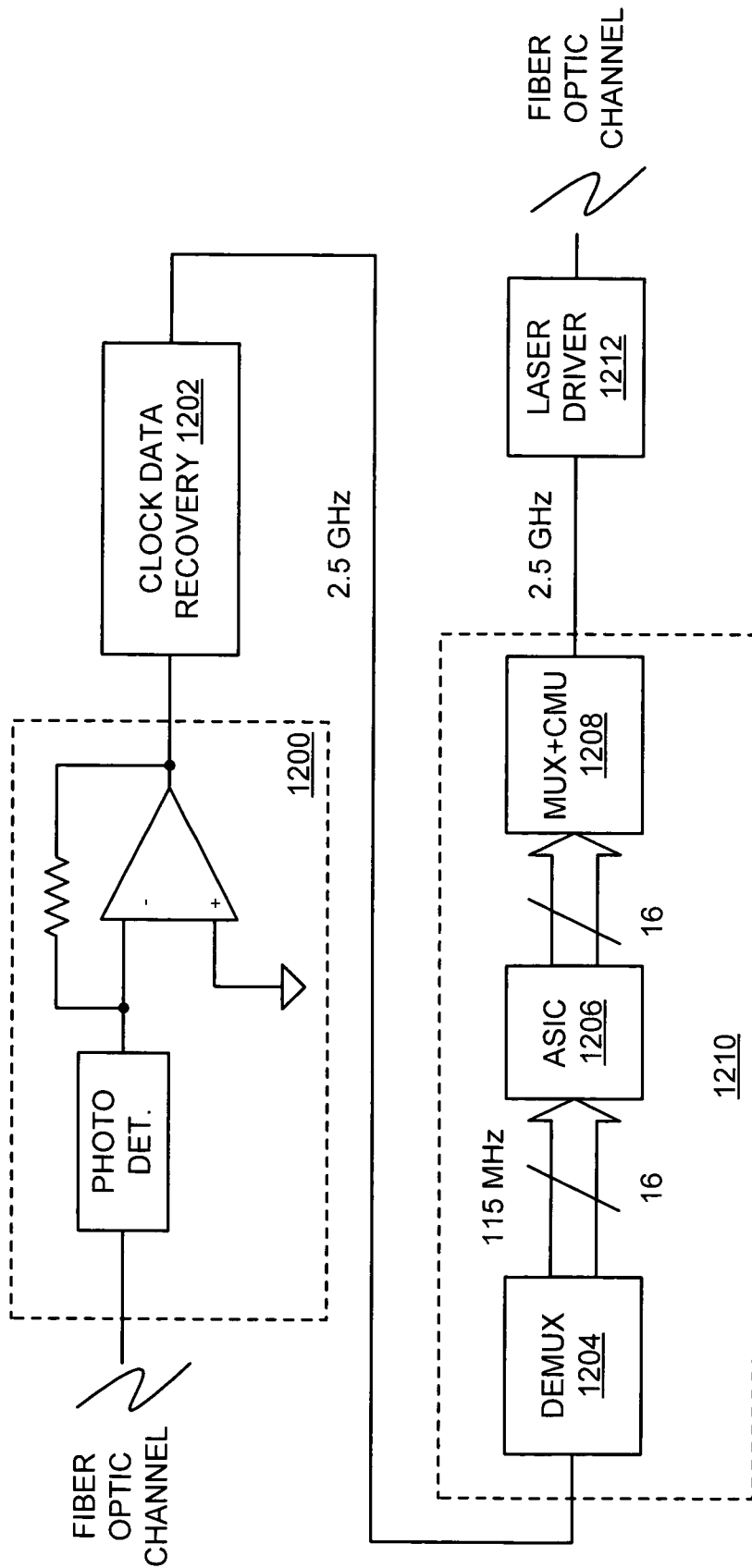


Fig. 12

## CURRENT-CONTROLLED CMOS LOGIC FAMILY

### CROSS REFERENCE TO RELATED PATENTS/PATENT APPLICATIONS

The present U.S. Utility Patent Application claims priority pursuant to 35 U.S.C. § 120, as a continuation, to the following U.S. Utility Patent Application which is hereby incorporated herein by reference in its entirety and made part of the present U.S. Utility patent application for all purposes:

1. U.S. Utility application Ser. No. 11/114,969, entitled "Current-controlled CMOS logic family," filed Apr. 26, 2005, now U.S. Pat. No. 7,038,516 B2, issued on May 2, 2006, which claims priority pursuant to 35 U.S.C. § 120, as a continuation, to the following U.S. Utility Patent Application which is hereby incorporated herein by reference in its entirety and made part of the present U.S. Utility Patent Application for all purposes:

2. U.S. Utility application Ser. No. 10/143,087, entitled "Current-controlled CMOS logic family," filed May 9, 2002, now U.S. Pat. No. 6,900,670 B2, issued on May 31, 2005, which claims priority pursuant to 35 U.S.C. § 120, as a continuation, to the following U.S. Utility Patent Application which is hereby incorporated herein by reference in its entirety and made part of the present U.S. Utility Patent Application for all purposes:

3. U.S. Utility application Ser. No. 09/484,856, entitled "Current-controlled CMOS logic family," filed Jan. 18, 2000, now U.S. Pat. No. 6,424,194 B1, issued on Jun. 23, 2002, which claims priority pursuant to 35 U.S.C. § 119(e) to the following U.S. Provisional Patent Application which is hereby incorporated herein by reference in its entirety and made part of the present U.S. Utility patent application for all purposes:

1. U.S. Provisional Application Ser. No. 60/141,355, entitled "Current-controlled CMOS logic family," filed Jun. 28, 1999.

### BACKGROUND OF THE INVENTION

The present invention relates in general to integrated circuitry, and in particular to complementary metal-oxide-semiconductor (CMOS) logic and circuits with enhanced speed characteristics.

For a number of reasons CMOS is the logic family of choice in today's VLSI devices. Due to the complementary nature of its operation, CMOS logic consumes near zero static power. CMOS also readily scales with technology. These two features are highly desirable given the drastic growth in demand for low power and portable electronic devices. Further, with the computer aided design (CAD) industry's focus on developing automated design tools for CMOS based technologies, the cost and the development time of CMOS VLSI devices has reduced significantly.

The one drawback of the CMOS logic family, however, remains its limited speed. That is, conventional CMOS logic has not achieved the highest attainable switching speeds made possible by modern sub-micron CMOS technologies. This is due to a number of reasons. Referring to FIG. 1, there is shown a conventional CMOS inverter **100**—the most basic building block of CMOS logic. A p-channel transistor **102** switches between the output and the positive power supply  $V_{cc}$ , and an n-channel transistor **104** switches between the output and the negative power supply (or ground). The switching speed in CMOS logic is inversely

proportional to the average on resistance ( $R_{on}$ ) of the MOS transistor, and the load capacitance  $C_L$  on a given node ( $\tau = R_{on} \times C_L$ ). The on resistance  $R_{on}$  is proportional to the transistor channel length  $L$  divided by the power supply voltage (i.e.,  $R_{on} \propto L/V_{cc}$ ), while the load capacitance is given by the gate capacitance of the transistor being driven (i.e.,  $W \times L \times C_{ox}$ , where  $C_{ox}$  is the gate oxide capacitance), plus the interconnect parasitic capacitance  $C_{int}$ . Therefore, with reduced transistor channel lengths  $L$ , the switching speed is generally increased. However, this relationship no longer holds in sub-micron technologies. As the channel length  $L$  in CMOS technology shrinks into the sub-micron range, the power supply voltage must be reduced to prevent potential damage to the transistors caused by effects such as oxide breakdown and hot-electrons. The reduction of the power supply voltage prevents the proportional lowering of  $R_{on}$  with the channel length  $L$ . Moreover, the load capacitance which in the past was dominated by the capacitances associated with the MOS device, is dominated by the routing or interconnect capacitance ( $C_{int}$ ) modern sub 0.5 micron technologies. This means that the load capacitance will not be reduced in proportion with the channel length  $L$ . Thus, the RC loading which is the main source of delaying the circuit remains relatively the same as CMOS technology moves in the sub-micron range.

As a result of the speed limitations of conventional CMOS logic, integrated circuit applications in the Giga Hertz frequency range have had to look to alternative technologies such as ultra high speed bipolar circuits and Gallium Arsenide (GaAs). These alternative technologies, however, have drawbacks of their own that have made them more of a specialized field with limited applications as compared to silicon MOSFET that has had widespread use and support by the industry. In particular, compound semiconductors such as GaAs are more susceptible to defects that degrade device performance, and suffer from increased gate leakage current and reduced noise margins. Furthermore, attempts to reliably fabricate a high quality oxide layer using GaAs have not thus far met with success. This has made it difficult to fabricate GaAs FETs, limiting the GaAs technology to junction field-effect transistors (JFETs) or Schottky barrier metal semiconductor field-effect transistors (MES-FETs). A major drawback of the bipolar technology, among others, is its higher current dissipation even for circuits that operate at lower frequencies.

It is therefore highly desirable to develop integrated circuit design techniques that are based on conventional silicon CMOS technology, but overcome the speed limitations of CMOS logic.

### BRIEF SUMMARY OF THE INVENTION

The present invention is directed to apparatus and methods of operation that are further described in the following Brief Description of the Several Views of the Drawings, the Detailed Description of the Invention, and the claims. Other features and advantages of the present invention will become apparent from the following detailed description of the invention made with reference to the accompanying drawings.

### BRIEF DESCRIPTION OF THE SEVERAL VIEWS OF THE DRAWINGS

FIG. 1 shows a conventional CMOS inverter; FIG. 2 is an inverter/buffer implemented in  $C^3$ MOS according to an exemplary embodiment of the present invention;

FIG. 3 shows an exemplary C<sup>3</sup>MOS level shift buffer according to the present invention;

FIGS. 4A and 4B show exemplary C<sup>3</sup>MOS implementations for an AND/NAND gate and an OR/NOR gate, respectively;

FIG. 5 shows an exemplary C<sup>3</sup>MOS implementation for a 2:1 multiplexer;

FIG. 6 shows an exemplary C<sup>3</sup>MOS implementation for a two-input exclusive OR/NOR gate;

FIG. 7 is a circuit schematic showing an exemplary C<sup>3</sup>MOS clocked latch according to the present invention;

FIG. 8 is a circuit schematic for an alternate embodiment for a C<sup>3</sup>MOS flip-flop according to the present invention;

FIG. 9 shows an exemplary C<sup>3</sup>MOS implementation for a flip-flop using the C<sup>3</sup>MOS latch of FIG. 7;

FIG. 10 shows a block diagram for a circuit that combines C<sup>3</sup>MOS and conventional CMOS logic on a single silicon substrate to achieve optimum tradeoff between speed and power consumption;

FIG. 11 shows an exemplary circuit application of the C<sup>3</sup>MOS/CMOS combined logic wherein C<sup>3</sup>MOS logic is used to deserialize and serialize the signal stream while CMOS logic is used as the core signal processing logic circuitry;

FIG. 12 is a simplified block diagram of a transceiver system that utilizes the C<sup>3</sup>MOS/CMOS combined logic according to the present invention to facilitate interconnecting high speed fiber optic communication channels.

#### DETAILED DESCRIPTION OF THE INVENTION

The present invention provides ultra high-speed logic circuitry implemented in silicon complementary metal-oxide-semiconductor (CMOS) process technology. A distinction is made herein between the terminology "CMOS process technology" and "CMOS logic." CMOS process technology as used herein refers generally to a variety of well established CMOS fabrication processes that form a field-effect transistor over a silicon substrate with a gate terminal typically made of polysilicon material disposed on top of an insulating material such as silicon dioxide. CMOS logic, on the other hand, refers to the use of complementary CMOS transistors (n-channel and p-channel) to form various logic gates and more complex logic circuitry, wherein zero static current is dissipated. The present invention uses current-controlled mechanisms to develop a family of very fast current-controlled CMOS (or C<sup>3</sup>MOS™) logic that can be fabricated using a variety of conventional CMOS process technologies, but that unlike conventional CMOS logic does not dissipate static current. C<sup>3</sup>MOS logic or current-controlled metal-oxide-semiconductor field-effect transistor (MOSFET) logic are used herein interchangeably.

In a preferred embodiment, the basic building block of this logic family is an NMOS differential pair with resistive loads. Referring to FIG. 2, there is shown one embodiment for the basic C<sup>3</sup>MOS inverter/buffer 200 according to the present invention. Inverter/buffer 200 includes a pair of n-channel MOSFETs 202 and 204 that receive differential logic signals D and D# at their gate terminals, respectively. Resistive loads 206 and 208 connect the drain terminals of MOSFETs 202 and 204, respectively, to the power supply Vcc. Drain terminals of MOSFETs 202 and 204 form the outputs OUT# and OUT of the inverter/buffer, respectively. Resistive loads 206 and 208 may be made up of either p-channel MOSFETs operating in their linear region, or resistors made up of, for example, polysilicon material. In a

preferred embodiment, polysilicon resistors are used to implement resistive loads 206 and 208, which maximize the speed of inverter/buffer 200. The source terminals of n-channel MOSFETs 202 and 204 connect together at node 210. A current-source n-channel MOSFET 212 connects node 210 to ground (or negative power supply). A bias voltage VB drives the gate terminal of current-source MOSFET 212 and sets up the amount of current I that flows through inverter/buffer 200. In response to the differential signal at D and D#, one of the two input n-channel MOSFETs 202 and 204 switches on while the other switches off. All of current I, thus flows in one leg of the differential pair pulling the drain terminal (OUT or OUT#) of the on transistor down to logic low, while the drain of the other (off) transistor is pulled up by its resistive load toward logic high. At the OUT output this circuit is a buffer, while at the OUT# output the circuit acts as an inverter.

Significant speed advantages are obtained by this type of current steering logic. Unlike the conventional CMOS inverter of FIG. 1, when either one of the input MOSFETs 202 or 204 is switching on, there is no p-channel pull-up transistor that fights the n-channel. Further, circuit 200 requires a relatively small differential signal to switch its transistors. This circuit also exhibits improved noise performance as compared to the CMOS inverter of FIG. 1, since in the C<sup>3</sup>MOS inverter/buffer, transistors do not switch between the power supply and the substrate. Logic circuitry based on current-steering techniques have been known in other technologies such as bipolar, where it is called emitter-coupled logic (ECL), and GaAs where it is called source-coupled FET logic (SCFL). This technique, however, has not been seen in silicon CMOS technology for a number of reasons, among which is the fact that CMOS logic has always been viewed as one that dissipates zero static current. The C<sup>3</sup>MOS logic as proposed by the present invention, on the other hand, does dissipate static current.

The design of each C<sup>3</sup>MOS logic cell according to the present invention is optimized based on several considerations including speed, current dissipation, and voltage swing. The speed of the logic gate is determined by the resistive load and the capacitance being driven. As discussed above, the preferred embodiment according to the present invention uses polysilicon resistors to implement the load devices. P-channel MOSFETs can alternatively be used, however, they require special biasing to ensure they remain in linear region. Further, the junction capacitances of the p-channel load MOSFETs introduce undesirable parasitics. Speed requirements place a maximum limit on the value of the resistive loads. On the other hand, the various C<sup>3</sup>MOS logic cells are designed to preferably maintain a constant voltage swing (I×R). Accordingly, the values for R and I are adjusted based on the capacitive load being driven to strike the optimum trade-off between switching speed and power consumption.

The C<sup>3</sup>MOS logic family, according to the present invention, contains all the building blocks of other logic families. Examples of such building blocks include inverters, buffers, level shift buffers, N-input NOR and NAND gates, exclusive OR (XOR) gates, flip flops and latches, and the like. FIG. 3 shows an exemplary C<sup>3</sup>MOS level shift circuit 300 according to the present invention. Level shift circuit 300 includes essentially the same circuit elements as inverter/buffer 200 shown in FIG. 2, with an additional resistor Rs 302 inserted between the power supply Vcc and the load resistors. Circuit 300 operates in the same fashion as inverter/buffer 200 except that it has its power supply voltage shifted by a value equal to (I×Rs). The C<sup>3</sup>MOS logic circuitry according to the

present invention employs this type of level shifter to make the necessary adjustments in the signal level depending on the circuit requirements. Examples of C<sup>3</sup>MOS circuits utilizing this type of level shifting will be described below in connection with other types of C<sup>3</sup>MOS logic elements.

FIGS. 4A and 4B show exemplary C<sup>3</sup>MOS implementations for an exemplary 2-input AND/NAND gate **400** and an exemplary 2-input OR/NOR gate **402**, respectively. These gates operate based on the same current steering principal as discussed above. A logic low signal at input B of AND/NAND gate **400** brings OUT to ground via Q4 while OUT# is pulled high by its load resistor. A logic low at the A input also pulls OUT to ground via Q2 and Q3 (B=high). OUT is pulled high only when both A and B are high disconnecting any path to ground. OUT# provides the inverse of OUT. OR/NOR gate **402** operates similarly to generate OR/NOR logic at its outputs. When another set of transistors are inserted in each leg of the differential pair as is the case for gates **400** and **402**, the signals driving the inserted transistors (Q3, Q4) need level shifting to ensure proper switching operation of the circuit. Thus, high speed C<sup>3</sup>MOS level shifters such as those presented in FIG. 3 can be employed to drive signals B and B#. In a preferred embodiment, since node OUT in both gates **400** and **402** must drive the additional parasitics associated transistors Q4, dummy load transistors DQL1 and DQL2 connect to node OUT# to match the loading conditions at both outputs.

FIG. 5 shows an exemplary C<sup>3</sup>MOS implementation for a 2:1 multiplexer **500**. Similar to the other C<sup>3</sup>MOS logic gates, multiplexer **500** includes a differential pair for each input, but multiplexer **500** further includes select transistors **502** and **504** inserted between the common source terminals of the differential pairs and the current source transistor in a cascade structure. By asserting one of the select input signals SELA or SELB, the bias current is steered to the differential pair associated with that select transistor. Thus, signal SELA steers the bias current to the differential pair with A and A# inputs, and signal SELB steers the bias current to the differential pair with B and B# inputs. Similar to gates **400** and **402**, the signals SELA and SELB driving 15 inserted transistors **502** and **504** need level shifting to ensure proper switching operation of the circuit.

FIG. 6 shows an exemplary C<sup>3</sup>MOS implementation for a two-input exclusive OR (XOR) gate **600**. This implementation includes two differential pairs **602** and **606** that share the same resistive load, receive differential signals A and A# at their inputs as shown, and have their drain terminals cross-coupled at the outputs. The other differential input signals B and B# are first level shifted by circuit **606** and then applied to cascade transistors **608** and **610** that are inserted between the differential pairs and the current source transistor. The circuit as thus constructed performs the XOR function on the two input signals A and B.

FIG. 7 is a circuit schematic showing an exemplary C<sup>3</sup>MOS clocked latch **700** according to the present invention. Latch **700** includes a first differential pair **702** that receives differential inputs D and D# at the gate terminals, and a second differential pair **704** that has its gate and drain terminals cross-coupled to the outputs of OUT and OUT# first differential pair **702**. Clocked transistors **706** and **708** respectively connect common-source nodes of differential pairs **702** and **704** to the current-source transistor. Complementary clock signals CK and CKB drive the gate terminals of clocked transistors **706** and **708**. Similar to the other C<sup>3</sup>MOS gates that have additional transistors inserted between the differential pair and the current-source transis-

tor, clock signals CK and CKB are level shifted by level shift circuits such as that of FIG. 3.

A C<sup>3</sup>MOS master-slave flip-flop **800** according to the present invention can be made by combining two latches **700** as shown in FIG. 8. A first latch **802** receives differential input signals D and D# and generates differential output signals QI and QI#. The differential output signals QI and QI# are then applied to the differential inputs of a second latch **804**. The differential outputs Q and Q# of second latch **804** provide the outputs of flip-flop **800**.

Every one of the logic gates described thus far may be implemented using p channel transistors. The use of p-channel transistors provides for various alternative embodiments for C<sup>3</sup>MOS logic gates. FIG. 9 shows one example of an alternative implementation for a C<sup>3</sup>MOS clocked latch **900** that uses p-channel transistors. In this embodiment, instead of inserting the n-channel clocked transistors between the common-source nodes of the differential pairs and the current-source transistor, p channel clocked transistors **902** and **904** connect between the common-source nodes and the power supply Vcc. This implementation also requires that each differential pair have a separate current-source transistor as shown. Clocked latch **900** operates essentially the same as latch **700** shown in FIG. 7, except the implementation is not as efficient both in terms of size and speed.

As illustrated by the various C<sup>3</sup>MOS logic elements described above, all of the building blocks of any logic circuitry can be constructed using the C<sup>3</sup>MOS technique of the present invention. More complex logic circuits such as shift registers, counters, frequency dividers, etc., can be constructed in C<sup>3</sup>MOS using the basic elements described above. As mentioned above, however, C<sup>3</sup>MOS logic does consume static power. The static current dissipation of C<sup>3</sup>MOS may become a limiting factor in certain large scale circuit applications. In one embodiment, the present invention combines C<sup>3</sup>MOS logic with conventional CMOS logic to achieve an optimum balance between speed and power consumption. According to this embodiment of the present invention, an integrated circuit utilizes C<sup>3</sup>MOS logic for the ultra high speed (e.g., GHz) portions of the circuitry, and conventional CMOS logic for the relatively lower speed sections. For example, to enable an integrated circuit to be used in ultra high speed applications, the input and output circuitry that interfaces with and processes the high speed signals is implemented using C<sup>3</sup>MOS. The circuit also employs C<sup>3</sup>MOS to divide down the frequency of the signals being processed to a low enough frequency where conventional CMOS logic can be used. The core of the circuit, according to this embodiment, is therefore implemented by conventional CMOS logic that consumes zero static current. FIG. 10 shows a simplified block diagram illustrating this exemplary embodiment of the invention. A C<sup>3</sup>MOS input circuit **1000** receives a high frequency input signal IN and outputs a divided down version of the signal IN/n. The lower frequency signal IN/n is then processed by core circuitry **1002** that is implemented in conventional CMOS logic. A C<sup>3</sup>MOS output circuit **1004** then converts the processed IN/n signal back to the original frequency (or any other desired frequency) before driving it onto the output node OUT.

An example of a circuit implemented using combined CMOS/C<sup>3</sup>MOS logic according to the present invention is shown in FIG. 11. C<sup>3</sup>MOS input circuitry **1100** is a deserializer that receives a serial bit stream at a high frequency of, for example, 2 GHz. A 2 GHz input clock signal CLK is divided down to 1 GHz using a C<sup>3</sup>MOS flip-flop **1102**, such as the one shown in FIG. 8, that is connected in a +2

feedback configuration. The 1 GHz output of flip-flop **1102** is then supplied to clock inputs of a pair of C<sup>3</sup>MOS latches **1104** and **1106**. Latches **1104** and **1106**, which may be of the type shown in FIG. 6, receive the 2 GHz input bit stream at their inputs and respectively sample the rising and falling edges of the input bit stream in response to the 1 GHz clock signal CLK12. The signal CLK12 which is applied to the B/B# inputs of each latch (the level shifted input; see FIG. 6), samples the input data preferably at its center. It is to be noted that the rise and fall times of the signal in CMOS logic is often very dependent on process variations and device matching. C<sup>3</sup>MOS logic, on the other hand, is differential in nature and therefore provides much improved margins for sampling.

Referring back to FIG. 11, block **11** thus deserializes the input bit stream with its frequency halved to allow for the use of conventional CMOS logic to process the signals. The signals at the outputs of latches **1104** and **1106** are applied to parallel processing circuitry **1108** that are implemented in conventional CMOS logic operating at 1 GHz. The reverse is performed at the output where a serializer **1110** receives the output signals from processing circuitry **1108** and serializes them using C<sup>3</sup>MOS logic. The final output signal is a bit stream with the original 2 GHz frequency. Circuit applications wherein this technique can be advantageously employed include high speed single or multi-channel serial links in communication systems.

As apparent from the circuit shown in FIG. 11, this technique doubles the amount of the core signal processing circuitry. However, since this part of the circuit is implemented in conventional CMOS logic, current dissipation is not increased by the doubling of the circuitry. Those skilled in the art appreciate that there can be more than one level of deserializing if further reduction in operating frequency is desired. That is, the frequency of the input signal can be divided down further by 4 or 8 or more if desired. As each resulting bit stream will require its own signal processing circuitry, the amount and size of the overall circuitry increases in direct proportion to the number by which the input signal frequency is divided. For each application, therefore, there is an optimum number depending on the speed, power and area requirements.

According to one embodiment of the present invention the combined C<sup>3</sup>MOS/CMOS circuit technique as shown in FIG. 11 is employed in a transceiver of the type illustrated in FIG. 12. The exemplary transceiver of FIG. 12 is typically found along fiber optic channels in high speed telecommunication networks. The transceiver includes at its input a photo detect and driver circuit **1200** that receives the input signal from the fiber optic channel. Circuit **1200** converts fiber-optic signal to packets of data and supplies it to a clock data recovery (CDR) circuit **1202**. CDR circuit **1202** recovers the clock and data signals that may be in the frequency range of about 2.5 GHz, or higher. Established telecommunication standards require the transceiver to perform various functions, including data monitoring and error correction. These functions are performed at a lower frequency. Thus, the transceiver uses a demultiplexer **1204** which deserializes the 2.5 GHz data stream into, for example, 16 parallel signals having a frequency of about 155 MHz. An application specific integrated circuit (ASIC) **1206** then performs the monitoring and error correction functions at the lower (155 MHz) frequency. A multiplexer and clock multiplication unit (CMU) **1208** converts the parallel signals back into a single bit stream at 2.5 GHz. This signal is then retransmitted back onto the fiber optic channel by a laser drive **1212**. The combined C<sup>3</sup>MOS/CMOS technique of the

present invention allows fabrication of demultiplexer **1204**, ASIC **1206** and multiplexer and CMU **1208** on a single silicon die, as indicated by reference numeral **1210**, in a similar fashion as described in connection with the circuit of FIGS. 10 and 11. That is, demultiplexer **1204** and multiplexer and CMU **1208** are implemented in C<sup>3</sup>MOS with ASIC **1206** implemented in conventional CMOS.

In conclusion, the present invention provides various circuit techniques for implementing ultra high speed circuits using current-controlled CMOS (C<sup>3</sup>MOS) logic fabricated in conventional CMOS process technology. An entire family of logic elements including inverter/buffers, level shifters, NAND, NOR, XOR gates, latches, flip-flops and the like have been developed using C<sup>3</sup>MOS according to the present invention. In one embodiment, the present invention advantageously combines high speed C<sup>3</sup>MOS logic with low power conventional CMOS logic. According to this embodiment circuits such as transceivers along fiber optic channels can be fabricated on a single chip where the ultra-high speed portions of the circuit utilize C<sup>3</sup>MOS and the relatively lower speed parts of the circuit use conventional CMOS logic. In another embodiment, the C<sup>3</sup>MOS logic circuitry receives a first power supply voltage that is higher than the power supply voltage used by the conventional CMOS logic circuitry. While the above is a complete description of the preferred embodiment of the present invention, it is possible to use various alternatives, modifications and equivalents. Therefore, the scope of the present invention should be determined not with reference to the above description but should, instead, be determined with reference to the appended claims, along with their full scope of equivalents.

What is claimed is:

1. An apparatus, comprising:

- a first circuit block, implemented using conventional complementary metal-oxide-semiconductor (CMOS) logic wherein substantially zero static current is dissipated, that is operable to receive and process a first signal thereby generating a second signal there from, wherein the first signal is a differential signal;
- a second circuit block, implemented using conventional CMOS logic wherein substantially zero static current is dissipated, that is operable to receive and process a third signal thereby generating a fourth signal there from, wherein the second signal is a differential signal; and
- a third circuit block, implemented using current-controlled complementary metal-oxide semiconductor (C<sup>3</sup>MOS) logic wherein logic levels are signaled by current steering in one of two or more branches in response to differential input signals, that is operable to: receive the second signal; receive the fourth signal; and process the second signal and the fourth signal thereby generating a fifth signal there from.

2. The apparatus of claim 1, wherein:

the fifth signal is a serialized signal that includes information contained within the second signal and the fourth signal.

3. The apparatus of claim 1, wherein:

the first signal has a first frequency; the second signal has the first frequency; and the fifth signal has a second frequency.

4. The apparatus of claim 1, wherein:

the first signal has a first frequency; the second signal has the first frequency; the fifth signal has a second frequency; and the second frequency is greater than the first frequency.

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- 5. The apparatus of claim 1, wherein:  
the first signal has a first frequency;  
the second signal has the first frequency;  
the fifth signal has a second frequency; and  
the second frequency is an integer multiple of the first frequency. 5
- 6. The apparatus of claim 1, further comprising:  
a fourth circuit block, implemented using current-controlled complementary metal-oxide semiconductor (C<sup>3</sup>MOS) logic wherein logic levels are signaled by current steering in one of two or more branches in response to differential input signals, that is operable to receive and process a sixth signal thereby generating the first signal and the third signal there from. 10
- 7. The apparatus of claim 6, wherein:  
the first signal has a first frequency;  
the second signal has the first frequency; and  
the fifth signal has a second frequency; and  
the sixth signal has the second frequency. 15
- 8. The apparatus of claim 1, wherein:  
the first circuit block, the second circuit block, and the third circuit block are all implemented on a single silicon die. 20
- 9. An apparatus, comprising:  
a first circuit block, implemented using current-controlled complementary metal-oxide semiconductor (C<sup>3</sup>MOS) logic wherein logic levels are signaled by current steering in one of two or more branches in response to differential input signals, that is operable to receive and process a first signal thereby generating a second signal and a third signal there from; 25  
a second circuit block, implemented using conventional complementary metal-oxide-semiconductor (CMOS) logic wherein substantially zero static current is dissipated, that is operable to receive and process the second signal thereby generating a fourth signal there from; 35  
and  
a third circuit block, implemented using conventional CMOS logic wherein substantially zero static current is dissipated, that is operable to receive and process the third signal thereby generating a fifth signal there from. 40
- 10. The apparatus of claim 9, wherein:  
the first circuit block deserializes the first signal thereby generating the second signal and the third signal there from such that the second signal includes first information contained within the first signal and the third signal includes second information contained within the first signal. 45
- 11. The apparatus of claim 9, wherein:  
the first signal has a first frequency;  
the second signal has a second frequency; and  
the third signal has the second frequency. 50
- 12. The apparatus of claim 9, wherein:  
the first signal has a first frequency;  
the second signal has a second frequency;  
the third signal has the second frequency; and  
the first frequency is greater than the second frequency. 55
- 13. The apparatus of claim 9, wherein:  
the first signal has a first frequency;  
the second signal has a second frequency;  
the third signal has the second frequency;  
the fourth signal has the second frequency; 60

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- the fifth signal has the second frequency; and  
the first frequency is greater than the second frequency.
- 14. The apparatus of claim 9, wherein:  
the first circuit block, the second circuit block, and the third circuit block are all implemented on a single silicon die.
- 15. An apparatus, comprising:  
a first circuit block, implemented using current-controlled complementary metal-oxide semiconductor (C<sup>3</sup>MOS) logic wherein logic levels are signaled by current steering in one of two or more branches in response to differential input signals, that is operable to receive and process a first signal thereby generating a second signal and a third signal there from;  
a second circuit block, implemented using conventional complementary metal-oxide semiconductor (CMOS) logic wherein substantially zero static current is dissipated, that is operable to receive and process the second signal thereby generating a fourth signal there from;  
a third circuit block, implemented using conventional CMOS logic wherein substantially zero static current is dissipated, that is operable to receive and process the third signal thereby generating a fifth signal there from.  
a fourth circuit block, implemented using current-controlled complementary metal-oxide semiconductor (C<sup>3</sup>MOS) logic wherein logic levels are signaled by current steering in one of two or more branches in response to differential input signals, that is operable to: receive the fourth signal;  
receive the fifth signal; and  
process the fourth signal and the fifth signal thereby generating a sixth signal there from.
- 16. The apparatus of claim 15 wherein:  
the first circuit block deserializes the first signal thereby generating the second signal and the third signal there from such that the second signal includes first information contained within the first signal and the third signal includes second information contained within the first signal.
- 17. The apparatus of claim 15, wherein:  
the fourth circuit block serializes the fourth signal and the fifth signal thereby generating the sixth signal such that the sixth signal includes information contained within the fourth signal and the fifth signal.
- 18. The apparatus of claim 15, wherein:  
the first signal has a first frequency;  
the second signal has a second frequency;  
the fourth signal has the second frequency; and  
the sixth signal has the first frequency.
- 19. The apparatus of claim 15, wherein:  
the first signal has a first frequency;  
the second signal has a second frequency;  
the third signal has the second frequency;  
the fourth signal has the second frequency;  
the fifth signal has the second frequency; and  
the sixth signal has the first frequency.
- 20. The apparatus of claim 15, wherein:  
the first circuit block, the second circuit block, the third circuit block, and the fourth circuit block are all implemented on a single silicon die.

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